



Product Change Notification

Change Notification #: 116687 - 00
Change Title: **Boxed Intel® NUC Kit, NUC6i7KYK, PCN 116687-00, Product Design, BIOS Update**
Date of Publication: December 31, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	January 18, 2019
Date of First Availability of Post-Conversion Material:	January 18, 2019

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

The Intel® NUC Kit SKUs listed in the products affected table below will have the following change.

- The BIOS will be updated from version KYSKLI70.86A.0058 to KYSKLI70.86A.0059. The BIOS update is to support the Thunderbolt IC update from B-stepping to C-stepping. A complete list of BIOS changes can be found in the BIOS release notes. The BIOS updates and release notes can be found at <http://downloadcenter.intel.com>.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS Update to ensure smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implication to our customers

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXNUC6I7KYK	944578	H90754-110	H90766-408	H90754-111	H90766-409
BOXNUC6I7KYK1	944579	H90755-110	H90766-408	H90755-111	H90766-409
BOXNUC6I7KYK2	944580	H90756-110	H90766-408	H90756-111	H90766-409
BOXNUC6I7KYK3	944581	H90757-110	H90766-408	H90757-111	H90766-409
BOXNUC6I7KYK4	944582	H90758-110	H90766-408	H90758-111	H90766-409

PCN Revision History:

Date of Revision:

December 31, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Europe Email: eccb@intel.com

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